- 8-Bit Resolution
- Easy Microprocessor Interface or Standalone Operation
- Operates Ratiometrically or With 5-V Reference
- Single Channel or Multiplexed Twin Channels With Single-Ended or Differential Input Options
- Input Range 0 to 5 V With Single 5-V Supply
- Inputs and Outputs Are Compatible With TTL and MOS
- Conversion Time of 32 μs at f<sub>clock</sub> = 250 kHz
- Designed to Be Interchangeable With National Semiconductor ADC0831 and ADC0832
- Total Unadjusted Error . . . ± 1 LSB

#### description

### TLC0831 ... D OR P PACKAGE (TOP VIEW) CS 1 8 V<sub>CC</sub> IN+ 2 7 CLK IN- 3 6 DO GND 4 5 REF

TLC0832...D OR P PACKAGE (TOP VIEW)

CS ( CH0 ( CH1 ( GND (	1 2 3	8 7 6	]V <sub>CC</sub> /REF ]CLK ]DO
GND [	4	5	] DI

These devices are 8-bit successive-approximation analog-to-digital converters. The TLC0831 has single input channels; the TLC0832 has multiplexed twin input channels. The serial output is configured to interface with standard shift registers or microprocessors.

The TLC0832 multiplexer is software configured for single-ended or differential inputs. The differential analog voltage input allows for common-mode rejection or offset of the analog zero input voltage value. In addition, the voltage reference input can be adjusted to allow encoding any smaller analog voltage span to the full 8 bits of resolution.

The operation of the TLC0831 and TLC0832 devices is very similar to the more complex TLC0834 and TLC0838 devices. Ratiometric conversion can be attained by setting the REF input equal to the maximum analog input signal value, which gives the highest possible conversion resolution. Typically, REF is set equal to  $V_{CC}$  (done internally on the TLC0832).

The TLC0831C and TLC0832C are characterized for operation from  $0^{\circ}$ C to  $70^{\circ}$ C. The TLC0831I and TLC0832I are characterized for operation from  $-40^{\circ}$ C to  $85^{\circ}$ C.

	PACKAGE							
TA	SMALL	. OUTLINE (D)	PLASTIC DIP (P)					
0°C to 70°C	TLC0831CD	TLC0832CD	TLC0831CP	TLC0832CP				
-40°C to 85°C	TLC0831ID	TLC0832ID	TLC0831IP	TLC0832IP				

#### **AVAILABLE OPTIONS**

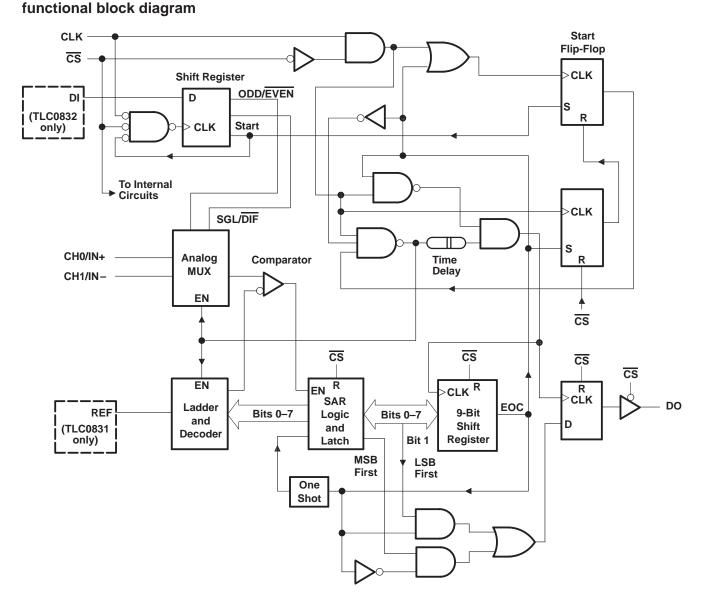


Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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### functional description

The TLC0831 and TLC0832 use a sample-data-comparator structure that converts differential analog inputs by a successive-approximation routine. The input voltage to be converted is applied to an input terminal and is compared to ground (single ended), or to an adjacent input (differential). The TLC0832 input terminals can be assigned a positive (+) or negative (–) polarity. The TLC0831 contains only one differential input channel with fixed polarity assignment; therefore it does not require addressing. The signal can be applied differentially, between IN+ and IN–, to the TLC0831 or can be applied to IN+ with IN– grounded as a single ended input. When the signal input applied to the assigned positive terminal is less than the signal on the negative terminal, the converter output is all zeros.

Channel selection and input configuration are under software control using a serial-data link from the controlling processor. A serial-communication format allows more functions to be included in a converter package with no increase in size. In addition, it eliminates the transmission of low-level analog signals by locating the converter at the analog sensor and communicating serially with the controlling processor. This process returns noise-free digital data to the processor.

A conversion is initiated by setting  $\overline{CS}$  low, which enables all logic circuits.  $\overline{CS}$  must be held low for the complete conversion process. A clock input is then received from the processor. An interval of one clock period is automatically inserted to allow the selected multiplexed channel to settle. DO comes out of the high-impedance state and provides a leading low for one clock period of multiplexer settling time. The SAR comparator compares successive outputs from the resistive ladder with the incoming analog signal. The comparator output indicates whether the analog input is greater than or less than the resistive-ladder output. As the conversion proceeds, conversion data is simultaneously output from DO, with the most significant bit (MSB) first. After eight clock periods, the conversion is complete. When  $\overline{CS}$  goes high, all internal registers are cleared. At this time, the output circuits go to the high-impedance state. If another conversion is desired,  $\overline{CS}$  must make a high-to-low transition followed by address information.

A TLC0832 input configuration is assigned during the multiplexer-addressing sequence. The multiplexer address shifts into the converter through the data input (DI) line. The multiplexer address selects the analog inputs to be enabled and determines whether the input is single ended or differential. When the input is differential, the polarity of the channel input is assigned. In addition to selecting the differential mode, the polarity may also be selected. Either channel of the channel pair may be designated as the negative or positive input.

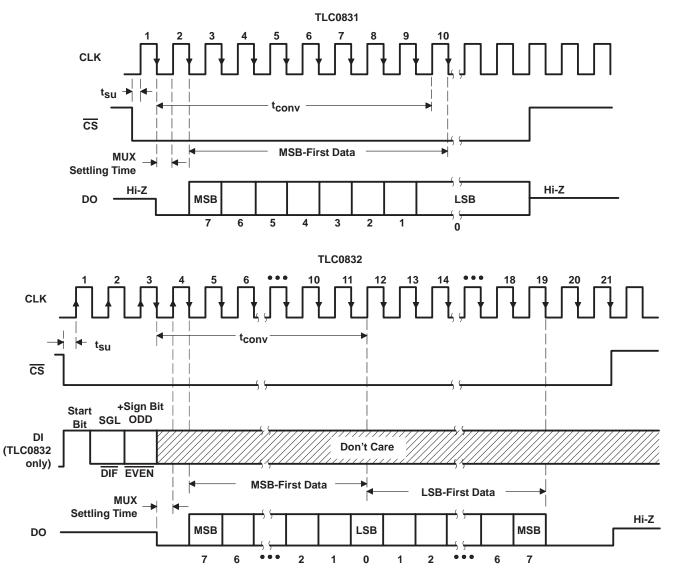
On each low-to-high transition of the clock input, the data on DI is clocked into the multiplexer-address shift register. The first logic high on the input is the start bit. A 2-bit assignment word follows the start bit on the TLC0832. On each successive low-to-high transition of the clock input, the start bit and assignment word are shifted through the shift register. When the start bit is shifted into the start location of the multiplexer register, the input channel is selected and conversion starts. The TLC0832 DI terminal to the multiplexer shift register is disabled for the duration of the conversion.

The TLC0832 outputs the least-significant-bit (LSB) first data after the MSB-first data stream. The DI and DO terminals can be tied together and controlled by a bidirectional processor I/O bit received on a single wire. This is possible because DI is only examined during the multiplexer-addressing interval and DO is still in the high-impedance state.



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### sequence of operation



#### TLC0832 MUX-ADDRESS CONTROL LOGIC TABLE

MUX A	DDRESS	CHANNEL NUMBER			
SGL/DIF	ODD/EVEN	CH0	CH1		
L	L	+	-		
L	Н	-	+		
Н	L	+			
Н	Н		+		

H = high level, L = low level,

- or + = terminal polarity for the selected input channel



# TLC0831C, TLC0831I TLC0832C, TLC0832I 8-BIT ANALOG-TO-DIGITAL CONVERTERS WITH SERIAL CONTROL

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#### absolute maximum ratings over recommended operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage, V <sub>CC</sub> (see Note 1)	<sub>C</sub> + 0.3 V
Input current, I <sub>I</sub>	. ±5 mA
Operating free-air temperature range, T <sub>A</sub> : C suffix	C to 70°C
Storage temperature range, T <sub>stg</sub> 65°C Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: P package	to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values, except differential voltages, are with respect to the network ground terminal.

#### recommended operating conditions

			MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>			4.5	5	5.5	V
High-level input voltage, VIH			2			V
Low-level input voltage, VIL					0.8	V
Clock frequency, f <sub>clock</sub>			10	10 600   40% 60%		kHz
Clock duty cycle (see Note 2)					60%	
Pulse duration, CS high, t <sub>wH(CS)</sub>			220			ns
Setup time, CS low or TLC0832 data va	Setup time, CS low or TLC0832 data valid before CLK <sup>↑</sup> , t <sub>SU</sub>					ns
Hold time, TLC0832 data valid after CL	↑, t <sub>h</sub>		90			ns
Operating free air temperature T.	C suffix		0		70	°C
Operating free-air temperature, $T_A$	I suffix		-40		85	U

NOTE 2: The clock-duty-cycle range ensures proper operation at all clock frequencies. When a clock frequency is used outside the recommended duty-cycle range, the minimum pulse duration (high or low) is 1 µs.



# electrical characteristics over recommended range of operating free-air temperature, $V_{CC} = 5 V$ , $f_{clock} = 250 \text{ kHz}$ (unless otherwise noted)

#### digital section

	DADAMETED	TEAT OO	NDITIONIST	(	C SUFFIX	[		I SUFFIX		UNIT
	PARAMETER	TEST CO	TEST CONDITIONS <sup>†</sup>		typ‡	MAX	MIN	TYP‡	MAX	UNIT
Val		V <sub>CC</sub> = 4.75 V,	I <sub>OH</sub> = -360 μA	2.8			2.4			V
VOH	High-level output voltage	V <sub>CC</sub> = 4.75 V,	I <sub>OH</sub> = -10 μA	4.6			4.5			V
VOL	Low-level output voltage	V <sub>CC</sub> = 4.75 V,	I <sub>OL</sub> = 1.6 mA	0.34			0.4			V
Iн	High-level input current	VIH = 5 V			0.005	1		0.005	1	μA
۱ <sub>IL</sub>	Low-level input current	VIL = 0			-0.005	-1		-0.005	-1	μΑ
I <sub>ОН</sub>	High-level output (source) current	$V_{OH} = V_{O}, A = 2$	25°C	-6.5	-24		-6.5	-24		mA
IOL	Low-level output (sink) current	$V_{OL} = V_{CC},$	$T_A = 25^{\circ}C$	8	26		8	26		mA
1	High-impedance-state output	V <sub>O</sub> = 5 V,	$T_A = 25^{\circ}C$		0.01	3		0.01	3	
loz	current (DO)	$V_{O} = 0,$	$T_A = 25^{\circ}C$		-0.01	-3		-0.01	-3	μA
Ci	Input capacitance				5			5		pF
Co	Output capacitance				5			5		рF

<sup>†</sup> All parameters are measured under open-loop conditions with zero common-mode input voltage.

<sup>‡</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> =  $25^{\circ}$ C.

#### analog and converter section

	PARAMETER		TEST CONDITIONS <sup>†</sup>	MIN	TYP‡	MAX	UNIT
VIC	Common-mode input voltage		See Note 3	-0.05 to V <sub>CC</sub> +0.05			V
		On channel	V <sub>I</sub> = 5 V			1	
he in s	Standby input surrent (ass Note 4)	Off channel	V <sub>I</sub> = 0			-1	
II(stdby)	Standby input current (see Note 4)	On channel	V <sub>I</sub> = 0			-1	μA
		Off channel	V <sub>I</sub> = 5 V			1	
<sup>r</sup> i(REF)	Input resistance to REF			1.3	2.4	5.9	kΩ

<sup>†</sup> All parameters are measured under open-loop conditions with zero common-mode input voltage.

<sup>‡</sup> All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

NOTES: 3. When channel IN– is more positive than channel IN+, the digital output code is 0000 0000. Connected to each analog input are two on-chip diodes that conduct forward current for analog input voltages one diode drop above V<sub>CC</sub>. Care must be taken during testing at low V<sub>CC</sub> levels (4.5 V) because high-level analog input voltage (5 V) can, especially at high temperatures, cause the input diode to conduct and cause errors for analog inputs that are near full scale. As long as the analog voltage does not exceed the supply voltage by more than 50 mV, the output code is correct. To achieve an absolute 0- to 5-V input range requires a minimum V<sub>CC</sub> of 4.95 V for all variations of temperature and load.

4. Standby input currents go in or out of the on or off channels when the A/D converter is not performing conversion and the clock is in a high or low steady-state conditions.

#### total device

	PARAMETER				MAX	UNIT
	Supply ourropt	TLC0831		0.6	1.25	m (
'CC	Supply current	TLC0832		2.5	4.7	mA

<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .



# operating characteristics $V_{CC} = V_{ref} = 5 V$ , $f_{clock} = 250 \text{ kHz}$ , $t_r = t_f = 20 \text{ ns}$ , $T_A = 25^{\circ}C$ (unless otherwise noted)

	PARAMETER		TEST CONDITIONS <sup>†</sup>	MIN TYP	MAX	UNIT
	Supply-voltage variation error		$V_{CC}$ = 4.75 V to 5.25 V	±1/16	±1/4	LSB
	Total unadjusted error (see Note 5)		$V_{ref} = 5 V,$ $T_A = MIN \text{ to MAX}$		±1	LSB
	Common-mode error	Differential mode	±1/16	±1/4	LSB	
÷ .	Propagation delay time,	MSB-first data	$C_{1} = 100 \text{ pE}$	650	1500	
<sup>t</sup> pd	output data after CLK $\uparrow$ (see Note 6)	LSB-first data	C <sub>L</sub> = 100 pF	250	600	ns
<b>*</b>	$\mathbf{D}$		$C_L = 10 \text{ pF},  R_L = 10 \text{ k}\Omega$	125	250	
<sup>t</sup> dis	Output disable time, DO after $\overline{CS}$		$C_L = 100 \text{ pF}, R_L = 2 \text{ k}\Omega$		500	ns
t <sub>conv</sub>	Conversion time (multiplexer-addressing time not included)			8	clock periods	

<sup>†</sup> All parameters are measured under open-loop conditions with zero common-mode input voltage. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

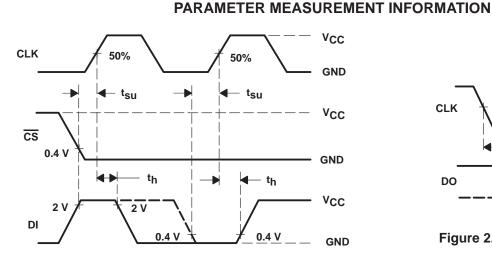
NOTES: 5. Total unadjusted error includes offset, full-scale, linearity, and multiplexer errors.

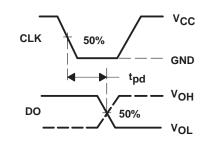
6. The MSB-first data is output directly from the comparator and, therefore, requires additional delay to allow for comparator response time. LSB-first data applies only to TLC0832.



# TLC0831C, TLC0831I TLC0832C, TLC0832I 8-BIT ANALOG-TO-DIGITAL CONVERTERS WITH SERIAL CONTROL

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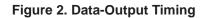
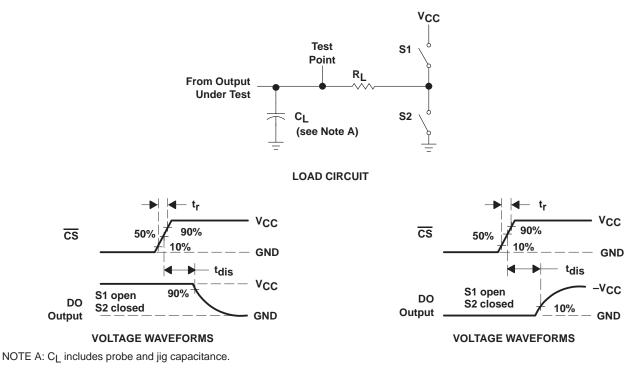


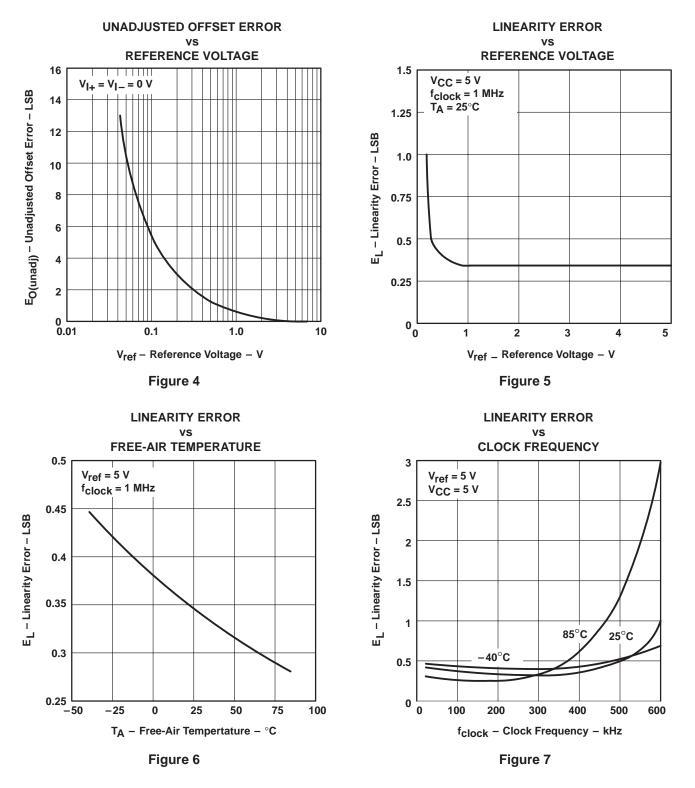
Figure 1. TLC0832 Data-Input Timing



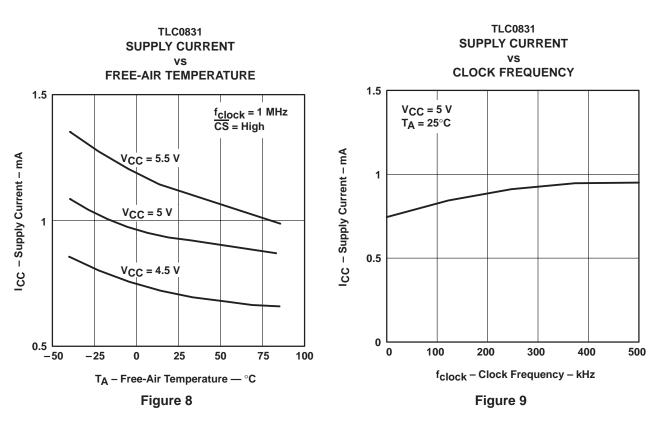




### **TYPICAL CHARACTERISTICS**







### **TYPICAL CHARACTERISTICS**

OUTPUT CURRENT vs FREE-AIR TEMPERATURE

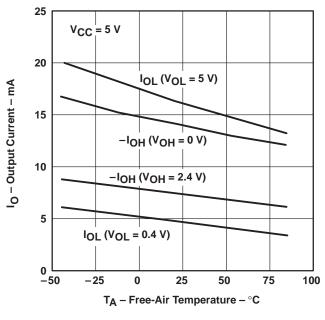
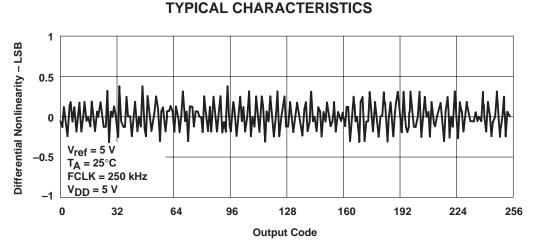
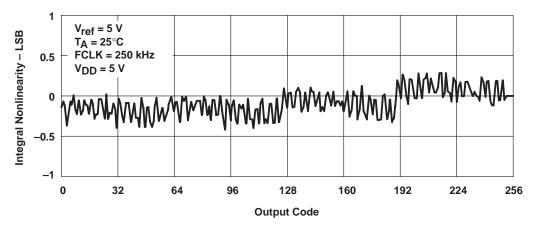


Figure 10

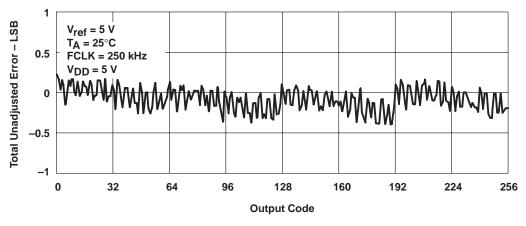


















# **PACKAGING INFORMATION**

Orderable part number	Status (1)	Material type	Package   Pins	Package qty   Carrier	<b>RoHS</b> (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
						(4)	(5)		
TLC0831CD	Active	Production	SOIC (D)   8	75   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	C0831C
TLC0831CD.A	Active	Production	SOIC (D)   8	75   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	C0831C
TLC0831CDR	Active	Production	SOIC (D)   8	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-	C0831C
TLC0831CDR.A	Active	Production	SOIC (D)   8	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	C0831C
TLC0831CP	Active	Production	PDIP (P)   8	50   TUBE	Yes	NIPDAU	N/A for Pkg Type	-	TLC0831CP
TLC0831CP.A	Active	Production	PDIP (P)   8	50   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TLC0831CP
TLC0831CPE4	Active	Production	PDIP (P)   8	50   TUBE	Yes	NIPDAU	N/A for Pkg Type	See TLC0831CP	TLC0831CP
TLC0831ID	Active	Production	SOIC (D)   8	75   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-	
TLC0831ID.A	Active	Production	SOIC (D)   8	75   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	
TLC0831IDR	Active	Production	SOIC (D)   8	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-	
TLC0831IDR.A	Active	Production	SOIC (D)   8	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	
TLC0831IP	Active	Production	PDIP (P)   8	50   TUBE	Yes	NIPDAU	N/A for Pkg Type	-	TLC0831IP
TLC0831IP.A	Active	Production	PDIP (P)   8	50   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TLC0831IP
TLC0832CD	Active	Production	SOIC (D)   8	75   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	C0832C
TLC0832CD.A	Active	Production	SOIC (D)   8	75   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	C0832C
TLC0832CDR	Active	Production	SOIC (D)   8	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-	C0832C
TLC0832CDR.A	Active	Production	SOIC (D)   8	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	C0832C
TLC0832CP	Active	Production	PDIP (P)   8	50   TUBE	Yes	NIPDAU	N/A for Pkg Type	-	TLC0832CP
TLC0832CP.A	Active	Production	PDIP (P)   8	50   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TLC0832CP
TLC0832ID	Active	Production	SOIC (D)   8	75   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-	C0832I
TLC0832ID.A	Active	Production	SOIC (D)   8	75   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	C0832I
TLC0832IDR	Active	Production	SOIC (D)   8	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-	C0832I
TLC0832IDR.A	Active	Production	SOIC (D)   8	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	C0832I
TLC0832IP	Active	Production	PDIP (P)   8	50   TUBE	Yes	NIPDAU	N/A for Pkg Type	-	TLC0832IP
TLC0832IP.A	Active	Production	PDIP (P)   8	50   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TLC0832IP
TLC0832IPE4	Active	Production	PDIP (P)   8	50   TUBE	Yes	NIPDAU	N/A for Pkg Type	See TLC0832IP	TLC0832IP

<sup>(1)</sup> **Status:** For more details on status, see our product life cycle.



# PACKAGE OPTION ADDENDUM

23-May-2025

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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Texas

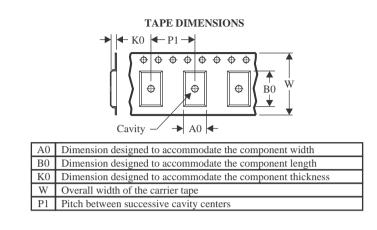
\*All dimensions are nominal

STRUMENTS

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### TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



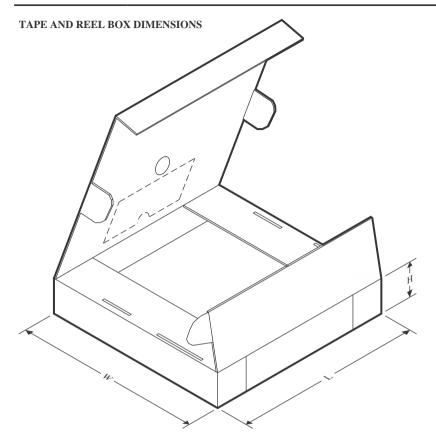
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLC0831CDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLC0831IDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLC0832CDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLC0832IDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1



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# PACKAGE MATERIALS INFORMATION

23-May-2025



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLC0831CDR	SOIC	D	8	2500	350.0	350.0	43.0
TLC0831IDR	SOIC	D	8	2500	350.0	350.0	43.0
TLC0832CDR	SOIC	D	8	2500	350.0	350.0	43.0
TLC0832IDR	SOIC	D	8	2500	350.0	350.0	43.0

### TEXAS INSTRUMENTS

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### TUBE



# - B - Alignment groove width

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
TLC0831CD	D	SOIC	8	75	505.46	6.76	3810	4
TLC0831CD.A	D	SOIC	8	75	505.46	6.76	3810	4
TLC0831CP	Р	PDIP	8	50	506	13.97	11230	4.32
TLC0831CP.A	Р	PDIP	8	50	506	13.97	11230	4.32
TLC0831CPE4	Р	PDIP	8	50	506	13.97	11230	4.32
TLC0831ID	D	SOIC	8	75	505.46	6.76	3810	4
TLC0831ID.A	D	SOIC	8	75	505.46	6.76	3810	4
TLC0831IP	Р	PDIP	8	50	506	13.97	11230	4.32
TLC0831IP.A	Р	PDIP	8	50	506	13.97	11230	4.32
TLC0832CD	D	SOIC	8	75	505.46	6.76	3810	4
TLC0832CD.A	D	SOIC	8	75	505.46	6.76	3810	4
TLC0832CP	Р	PDIP	8	50	506	13.97	11230	4.32
TLC0832CP.A	Р	PDIP	8	50	506	13.97	11230	4.32
TLC0832ID	D	SOIC	8	75	505.46	6.76	3810	4
TLC0832ID.A	D	SOIC	8	75	505.46	6.76	3810	4
TLC0832IP	Р	PDIP	8	50	506	13.97	11230	4.32
TLC0832IP.A	Р	PDIP	8	50	506	13.97	11230	4.32
TLC0832IPE4	Р	PDIP	8	50	506	13.97	11230	4.32

# D0008A



# **PACKAGE OUTLINE**

# SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



#### NOTES:

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.

- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.
- 5. Reference JEDEC registration MS-012, variation AA.



# D0008A

# **EXAMPLE BOARD LAYOUT**

# SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# D0008A

# **EXAMPLE STENCIL DESIGN**

# SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

9. Board assembly site may have different recommendations for stencil design.



P(R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 variation BA.



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